

Doc. no. 1SAA952002-2401

Rev. ind.

Date 2001-12-07

From Guenther Steinleitner

Dept. DESTO/Q

Phone +49 6221 701-1221 Fax +49 6221 701-1358

E-mail guenther.steinleitner@de.abb.com

Environmental Information

The purpose of this document is to provide environmental information requested in the procedure for Industrial ^{IT} Enabled level 0.

Product name	1SIxxx-xxx-Vx-xx, 1SCxxx-xxx-Vx-xx, 1SOxxx-xxx-Vx-xx
ABB Identity number	
Information provided by	Guenther Steinleitner
(Name and e-mail address)	Guenther.Steinleitner@de.abb.com
Business area	Low Voltage Products – ATLV
Date	December 2001

1. Related documents

Industrial ^{IT} Architecture - Introduction and Definitions, 3BSE023904

Industrial ^{IT} Certification Overview, 3BSE023905

Industrial IT Certification Guideline, 3BSE024526

Industrial T Enabled Level 0 - Information, Introduction and Definitions, 3BSE025934

Ref documents:

http://inside.abb.com/The Insider/Featured Portals/Industrial IT Deployment/06 Product Certification/Document Library

Doc. no. 1SAA952002-2401

Rev. ind.

Date 2001-12-07

2. Environmental Information

2.1 Content of hazardous materials

Declare the presence of hazardous materials in the product. Printed circuit boards are declared separately under 2.1.1 and should be excluded from the declaration in the table below.

Material	Example application	Yes	No	Quantity/unit
				Optional ⁽¹⁾
Lead	Batteries, cables, solder		✓	
Cadmium	Batteries, switches, additive in lead		✓	
Mercury	Batteries, switches		✓	
Beryllium	Contact springs		✓	
Brominated flame	Additive in plastics or rubber		✓	
retardants, e.g: PBB, PBDE, TBBPA				
HCFCs, e.g:	Cooling media		✓	
R 22, R 123, R 141b	-			
SF6, sulphurhexafluoride	Breakers		✓	
Polyvinyl chloride, PVC	Cables	√		

⁽¹⁾ Strive to declare the quantity. This is optional, however, since it is today sometimes difficult to retrieve such information, especially regarding supplied components.

2.1.1 Printed circuit boards

Specify the amount of printe	ed circuit boards	s used in the prod	duct by declaring	g the total
board surface:				

		. 2
✓	< 1	dm^2

☐ 1-10 dm²

 \Box > 10 dm²

☐ No printed circuit boards used in the product

1SAA952002-2401

Doc. no.

			Rev. ind.	
			Date 2001-12-07	
2.2 Recycl	ing info	rmation		
	Is red	cycling ir	nformation for the product available?	
		Yes	Ref. Document:	
	✓	No		
		, please rial is pr	e specify, in the table below, the component/part/physical position	n where the
Material			Component/part/physical position	
Lead			Solder points on printed circuit board, encapsulated with moulding compo	und
Cadmium				
Mercury				
Beryllium				
Brominated fla	ame retard	dants		
HCFCs				
SF6, sulphurhexafluoride		le		
Polyvinyl chloride, PVC			PVC cable, 2m	
2.3 Energy			ses during the operation of the product	
		ergy use mentation	e and/or losses during operation of the product specified in the pon?	product
		Yes	Ref. Document :	
	✓	No		
		Not re	elevant	